

# 6MBI75VA-060-50

**IGBT Modules**

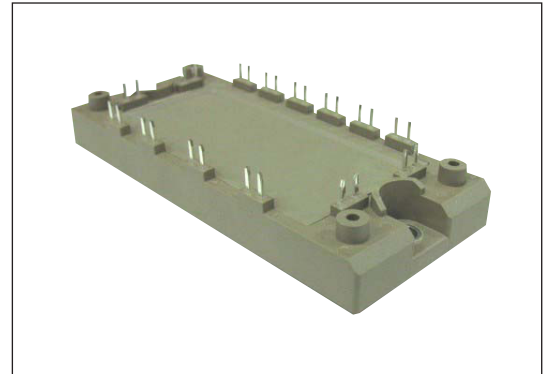
## IGBT MODULE (V series) 600V / 75A / 6 in one package

### ■ Features

- Compact Package
- P.C.Board Mount
- Low  $V_{CE(sat)}$

### ■ Applications

- Inverter for Motor Drive
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply
- Industrial machines, such as welding machines



### ■ Maximum Ratings and Characteristics

#### ● Absolute Maximum Ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)

Items		Symbols	Conditions		Maximum ratings	Units
Inverter	Collector-Emitter voltage	$V_{CES}$			600	V
	Gate-Emitter voltage	$V_{GES}$			$\pm 20$	V
	Collector current	$I_c$	Continuous	$T_c=80^\circ\text{C}$	75	A
		$I_{cp}$	1ms	$T_c=80^\circ\text{C}$	150	
		$-I_c$			75	
		$-I_c$ pulse	1ms		150	
Collector power dissipation	$P_c$	1 device		275	W	
Junction temperature	$T_j$			175	°C	
Operating junction temperature (under switching conditions)	$T_{jop}$			150		
Case temperature	$T_c$			125		
Storage temperature	$T_{stg}$			-40 to +125		
Isolation voltage	between terminal and copper base (*1) between thermistor and others (*2)	$V_{iso}$	AC : 1min.		2500	VAC
Screw torque	Mounting (*3)	-	M5		3.5	N m

Note \*1: All terminals should be connected together during the test.

Note \*2: Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

Note \*3: Recommendable value : 2.5-3.5 Nm (M5)

● Electrical characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

Items	Symbols	Conditions	Characteristics			Units		
			min.	typ.	max.			
Inverter	Zero gate voltage collector current	I <sub>CEs</sub>	V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V	-	-	1.0	mA	
	Gate-Emitter leakage current	I <sub>GES</sub>	V <sub>GE</sub> = 0V, V <sub>GE</sub> = ±20V	-	-	200	nA	
	Gate-Emitter threshold voltage	V <sub>GE(th)</sub>	V <sub>CE</sub> = 20V, I <sub>c</sub> = 75mA	6.2	6.7	7.2	V	
	Collector-Emitter saturation voltage	V <sub>CE(sat)</sub> (terminal)	V <sub>GE</sub> = 15V I <sub>c</sub> = 75A	T <sub>j</sub> = 25°C	-	2.00	2.45	V
				T <sub>j</sub> = 125°C	-	2.30	-	
				T <sub>j</sub> = 150°C	-	2.50	-	
		V <sub>CE(sat)</sub> (chip)	V <sub>GE</sub> = 15V I <sub>c</sub> = 75A	T <sub>j</sub> = 25°C	-	1.60	2.05	
				T <sub>j</sub> = 125°C	-	1.90	-	
	T <sub>j</sub> = 150°C	-	2.10	-				
	Internal gate resistance	R <sub>g(int)</sub>	-	-	0	-	Ω	
	Input capacitance	C <sub>ies</sub>	V <sub>CE</sub> = 10V, V <sub>GE</sub> = 0V, f = 1MHz	-	4.9	-	nF	
	Turn-on time	ton	V <sub>CC</sub> = 300V I <sub>c</sub> = 75A	-	0.36	1.20	μs	
		tr		-	0.25	0.60		
		tr(i)		-	0.07	-		
	Turn-off time	toff	V <sub>GE</sub> = +15 / -15V R <sub>G</sub> = 30Ω	-	0.52	1.20	μs	
tf		-		0.03	0.45			
Forward on voltage	V <sub>F</sub> (terminal)	I <sub>F</sub> = 75A	T <sub>j</sub> = 25°C	-	2.00	2.45	V	
			T <sub>j</sub> = 125°C	-	1.90	-		
			T <sub>j</sub> = 150°C	-	1.85	-		
	V <sub>F</sub> (chip)	I <sub>F</sub> = 75A	T <sub>j</sub> = 25°C	-	1.60	2.05		
			T <sub>j</sub> = 125°C	-	1.50	-		
T <sub>j</sub> = 150°C	-	1.45	-					
Reverse recovery time	trr	I <sub>F</sub> = 75A	-	-	0.35	μs		
Thermistor	Resistance	R	T = 25°C	-	5000	-	Ω	
		T = 100°C	465	495	520			
B value	B	T = 25 / 50°C	3305	3375	3450	K		

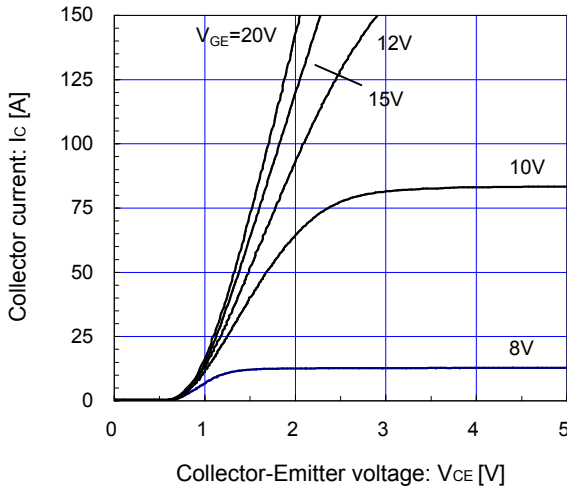
## ● Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance (1device)	R <sub>th(j-c)</sub>	Inverter IGBT	-	-	0.50	°C/W
		Inverter FWD	-	-	0.95	
Contact thermal resistance (1device) (*4)	R <sub>th(c-f)</sub>	with Thermal Compound	-	0.05	-	

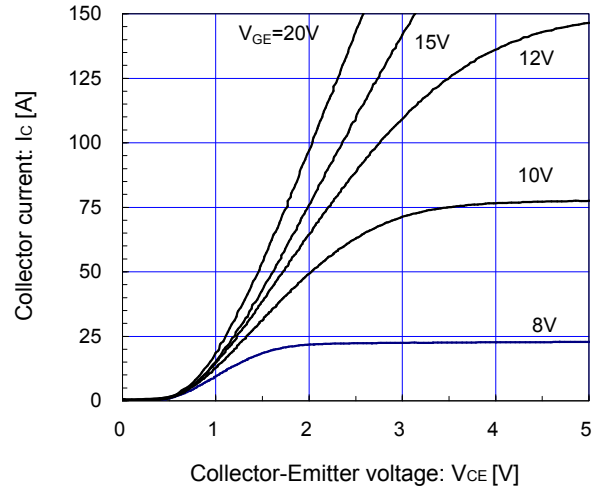
Note \*4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Characteristics (Representative)

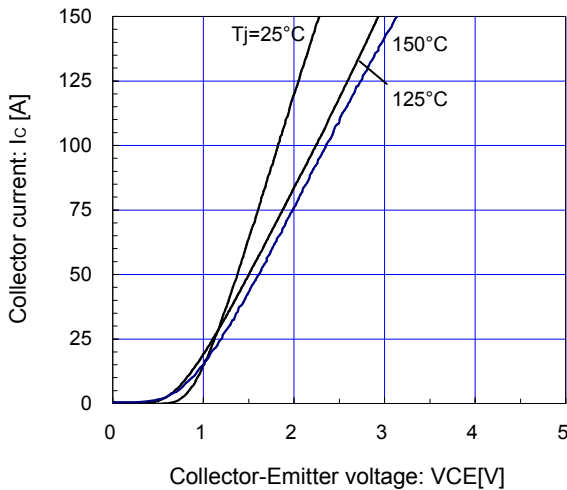
[ Inverter ]  
Collector current vs. Collector-Emittor voltage (typ.)  
 $T_j = 25^\circ\text{C}$  / chip



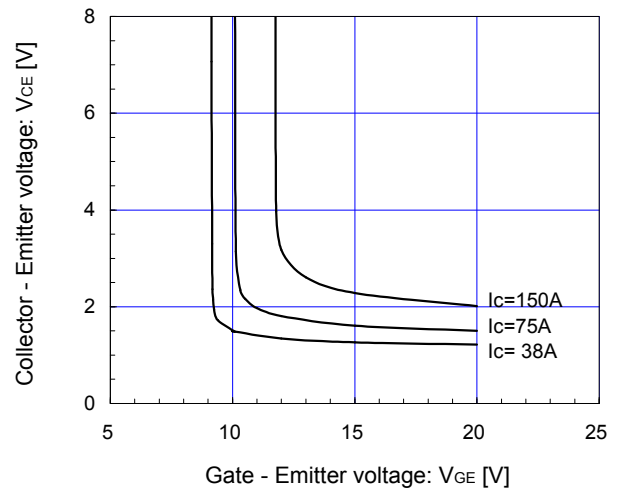
[ Inverter ]  
Collector current vs. Collector-Emittor voltage (typ.)  
 $T_j = 150^\circ\text{C}$  / chip



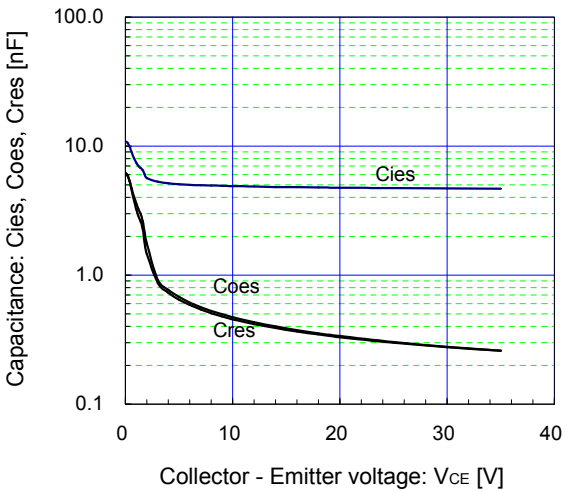
[ Inverter ]  
Collector current vs. Collector-Emittor voltage (typ.)  
 $V_{GE} = 15\text{V}$  / chip



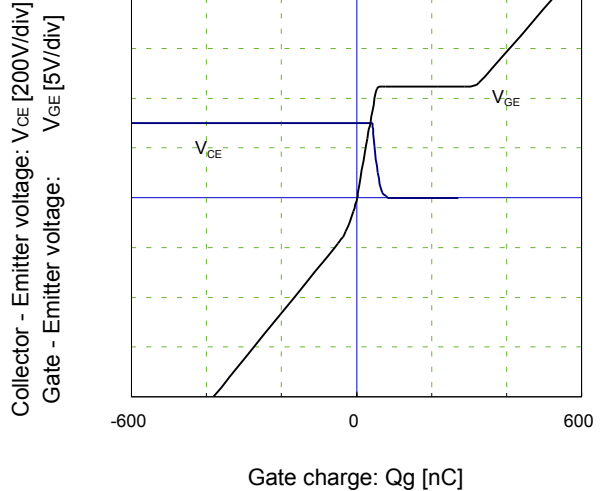
[ Inverter ]  
Collector-Emittor voltage vs. Gate-Emittor voltage (typ.)  
 $T_j = 25^\circ\text{C}$  / chip



[ Inverter ]  
Capacitance vs. Collector-Emittor voltage (typ.)  
 $V_{GE} = 0\text{V}$ ,  $f = 1\text{MHz}$ ,  $T_j = 25^\circ\text{C}$

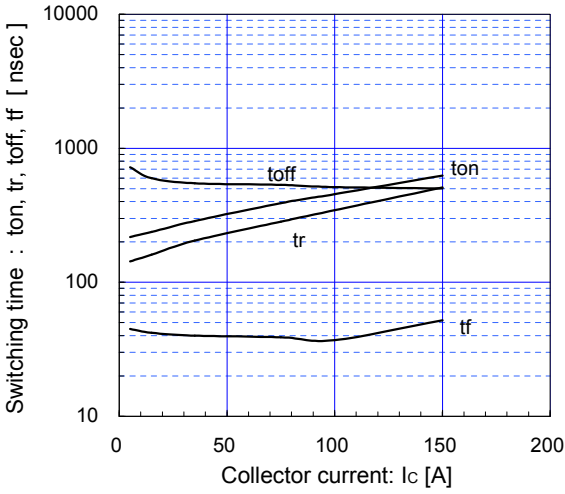


[ Inverter ]  
Dynamic gate charge (typ.)  
 $V_{CC} = 300\text{V}$ ,  $I_C = 75\text{A}$ ,  $T_j = 25^\circ\text{C}$



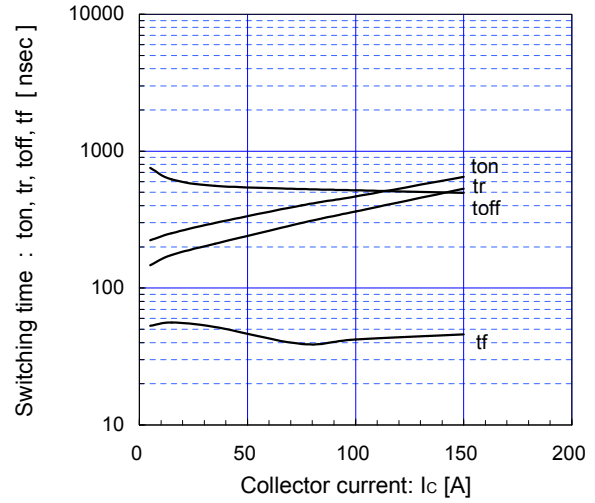
[ Inverter ]

Switching time vs. Collector current (typ.)  
 $V_{CC}=300V, V_{GE}=\pm 15V, R_g=30\Omega, T_j=125^\circ C$



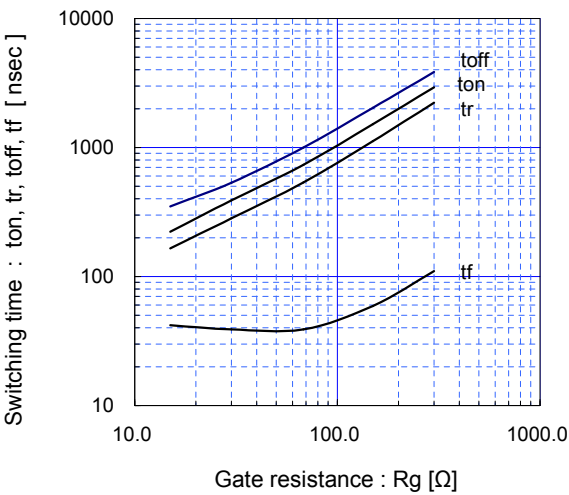
[ Inverter ]

Switching time vs. Collector current (typ.)  
 $V_{CC}=300V, V_{GE}=\pm 15V, R_g=30\Omega, T_j=150^\circ C$



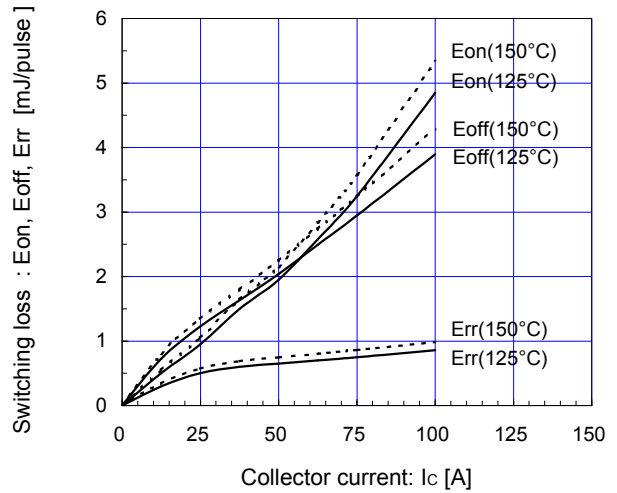
[ Inverter ]

Switching time vs. gate resistance (typ.)  
 $V_{CC}=300V, I_c=75A, V_{GE}=\pm 15V, T_j=125^\circ C$



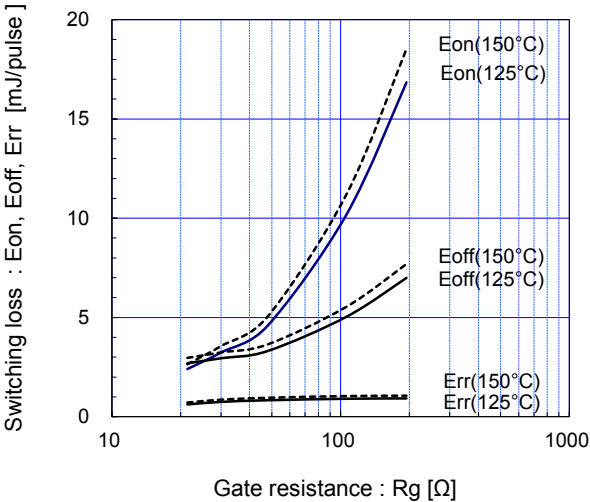
[ Inverter ]

Switching loss vs. Collector current (typ.)  
 $V_{CC}=300V, V_{GE}=\pm 15V, R_g=30\Omega$



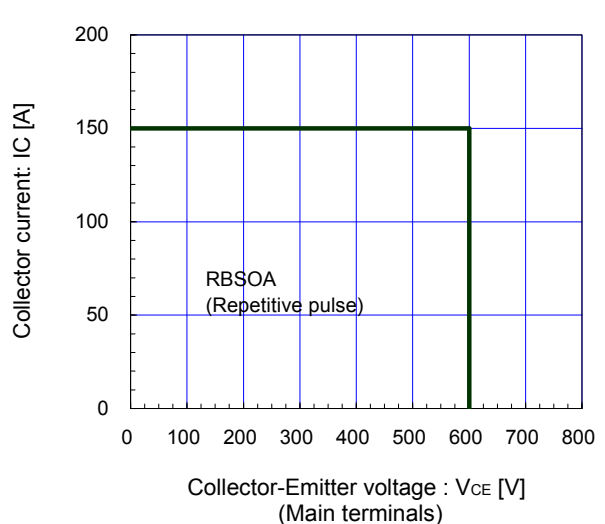
[ Inverter ]

Switching loss vs. gate resistance (typ.)  
 $V_{CC}=300V, I_c=75A, V_{GE}=\pm 15V$

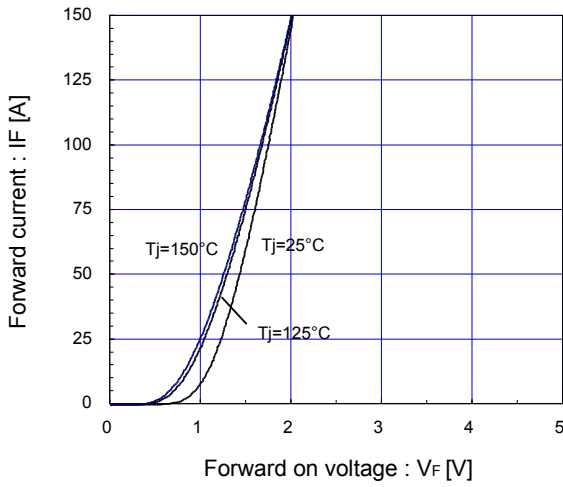


[ Inverter ]

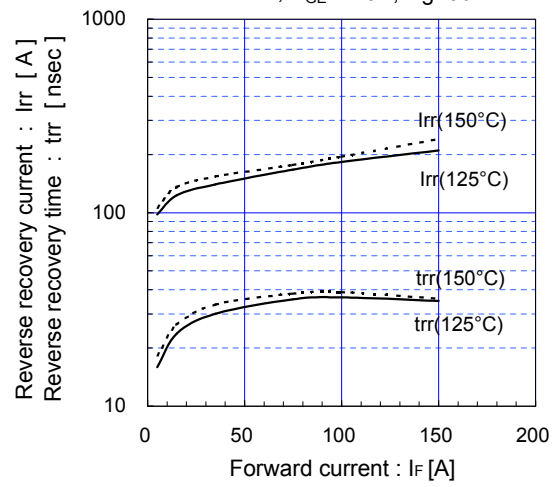
Reverse bias safe operating area (max.)  
 $+V_{GE}=15V, -V_{GE} \leq 15V, R_g \geq 30\Omega, T_j = 150^\circ C$



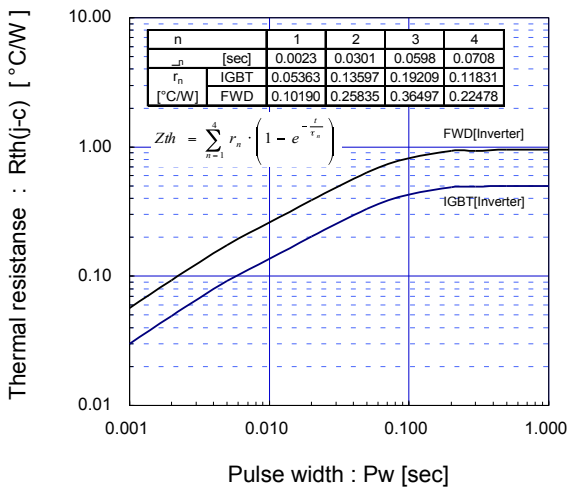
[ Inverter ]  
Forward current vs. forward on voltage (typ.)  
chip



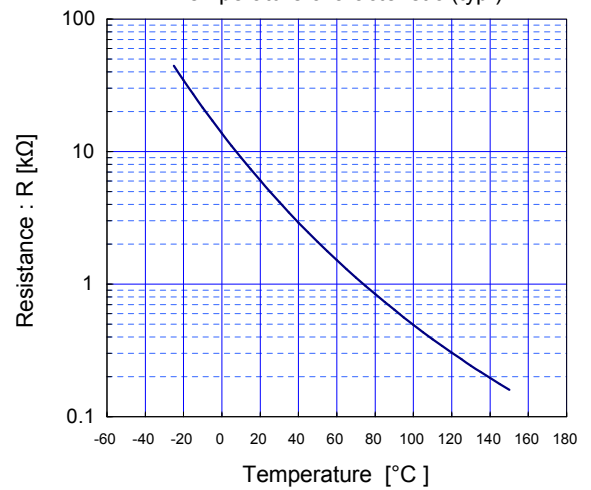
[ Inverter ]  
Reverse recovery characteristics (typ.)  
Vcc=300V, VGE=±15V, Rg=30Ω



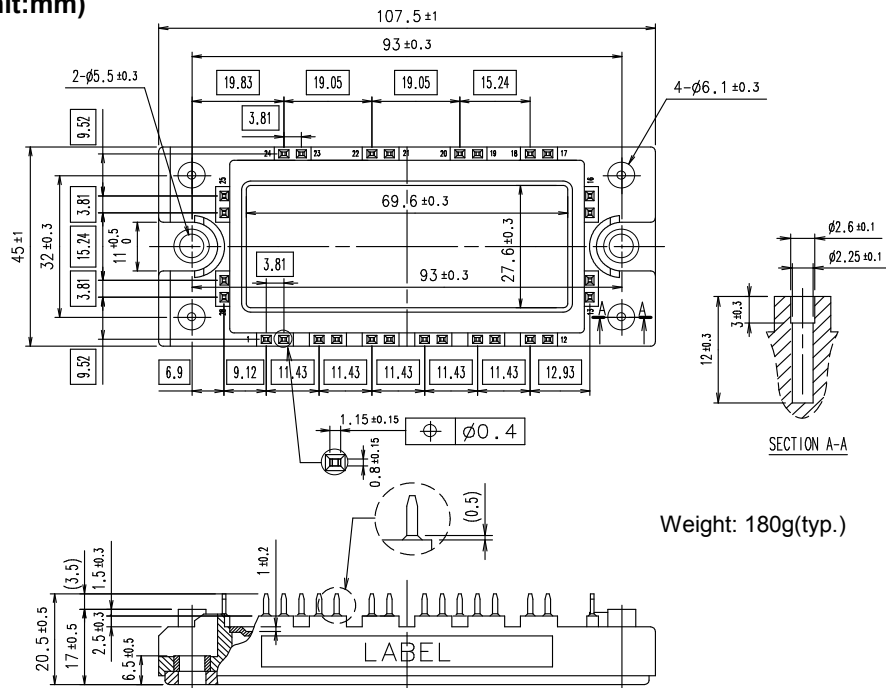
Transient thermal resistance (max.)



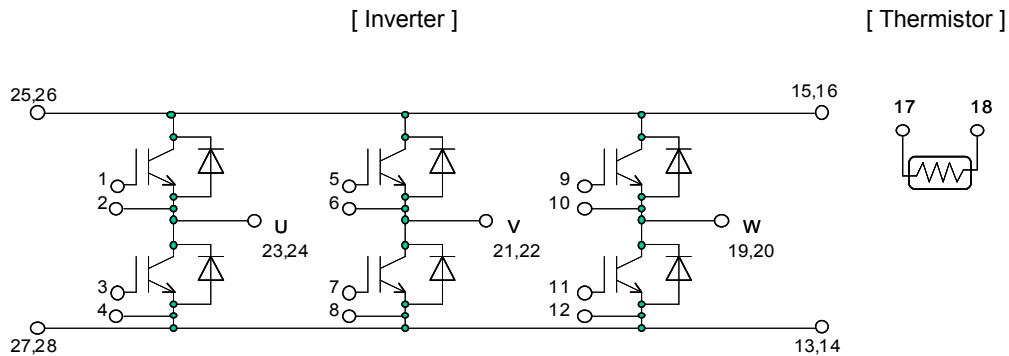
[ Thermistor ]  
Temperature characteristic (typ.)



■ Outline Drawings(Unit:mm)



## ■ Equivalent Circuit



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